

DEPARTMENT OF THE INTERIOR**Bureau of Ocean Energy Management (BOEM)****Notice on Outer Continental Shelf Oil and Gas Lease Sales**

AGENCY: Bureau of Ocean Energy Management, Interior.

ACTION: List of Restricted Joint Bidders.

SUMMARY: Pursuant to the authority vested in the Director of the Bureau of Ocean Energy Management by the joint bidding provisions of 30 CFR 556.41, each entity within one of the following groups shall be restricted from bidding with any entity in any of the other following groups at Outer Continental Shelf oil and gas lease sales to be held during the bidding period November 1, 2012 through April 30, 2013. This List of Restricted Joint Bidders will cover the period November 1, 2012 thru April 30, 2013, and replace the prior list published on April 26, 2012; which covered the period of May 1, 2012, to October 31, 2012.

Group I. Exxon Mobil Corporation

ExxonMobil Exploration Company

Group II. Shell Oil Company

Shell Offshore Inc.
SWEPI LP
Shell Frontier Oil & Gas Inc.
SOI Finance Inc.
Shell Gulf of Mexico Inc.

Group III. BP America Production Company

BP Exploration & Production Inc.
BP Exploration (Alaska) Inc.

Group IV. Chevron Corporation

Chevron U.S.A. Inc.
Chevron Midcontinent, L.P.
Unocal Corporation
Union Oil Company of California
Pure Partners, L.P.

Group V. ConocoPhillips Company

ConocoPhillips Alaska, Inc.
Phillips Pt. Arguello Production Company
Burlington Resources Oil & Gas Company LP
Burlington Resources Offshore Inc.
The Louisiana Land and Exploration Company
Inxeco Oil Company

Group VI. Eni Petroleum Co. Inc.

Eni Petroleum US LLC
Eni Oil US LLC
Eni Marketing Inc
Eni BB Petroleum Inc.
Eni US Operating Co. Inc.
Eni BB Pipeline LLC

Group VII. Statoil ASA

Statoil Gulf of Mexico LLC
Statoil USA E&P Inc.
Statoil Gulf Properties Inc.

Group VIII. Petrobras America Inc.

Petroleo Brasileiro S.A.

Group IX. Total E&P USA, Inc.

Dated: October 10, 2012.

Tommy P. Beaudreau,
Director, Bureau of Ocean Energy Management.

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INTERNATIONAL TRADE COMMISSION

[Investigation No. 337-TA-859]

Certain Integrated Circuit Chips and Products Containing the Same; Institution of Investigation Pursuant to United States Code

AGENCY: U.S. International Trade Commission.

ACTION: Notice.

SUMMARY: Notice is hereby given that a complaint was filed with the U.S. International Trade Commission on September 19, 2012, under section 337 of the Tariff Act of 1930, as amended, 19 U.S.C. 1337, on behalf of Realtek Semiconductor Corporation of Taiwan. A letter supplementing the Complaint was filed on October 5, 2012. The complaint alleges violations of section 337 based upon the importation into the United States, the sale for importation, and the sale within the United States after importation of certain integrated circuit chips and products containing the same by reason of infringement of certain claims of U.S. Patent No. 6,787,928 ("the '928 patent") and U.S. Patent No. 6,963,226 ("the '226 patent"). The complaint further alleges that an industry in the United States exists as required by subsection (a)(2) of section 337.

The complainant requests that the Commission institute an investigation and, after the investigation, issue an exclusion order and cease and desist orders.

ADDRESSES: The complaint, except for any confidential information contained therein, is available for inspection during official business hours (8:45 a.m. to 5:15 p.m.) in the Office of the Secretary, U.S. International Trade Commission, 500 E Street SW., Room 112, Washington, DC 20436, telephone (202) 205-2000. Hearing impaired

individuals are advised that information on this matter can be obtained by contacting the Commission's TDD terminal on (202) 205-1810. Persons with mobility impairments who will need special assistance in gaining access to the Commission should contact the Office of the Secretary at (202) 205-2000. General information concerning the Commission may also be obtained by accessing its Internet server at <http://www.usitc.gov>. The public record for this investigation may be viewed on the Commission's electronic docket (EDIS) at <http://edis.usitc.gov>.

FOR FURTHER INFORMATION CONTACT: The Office of the Secretary, Dockets Division, U.S. International Trade Commission, telephone (202) 205-1802.

Authority: The authority for institution of this investigation is contained in section 337 of the Tariff Act of 1930, as amended, and in section 210.10 of the Commission's Rules of Practice and Procedure, 19 CFR 210.10 (2012). Scope of Investigation: Having considered the complaint, the U.S. International Trade Commission, on October 16, 2012, *ordered that*—

(1) Pursuant to subsection (b) of section 337 of the Tariff Act of 1930, as amended, an investigation be instituted to determine whether there is a violation of subsection (a)(1)(B) of section 337 in the importation into the United States, the sale for importation, or the sale within the United States after importation of certain integrated circuit chips and products containing the same that infringe one or more of claims 1-22 of the '928 patent and claims 1-22 of the '226 patent, and whether an industry in the United States exists as required by subsection (a)(2) of section 337;

(2) For the purpose of the investigation so instituted, the following are hereby named as parties upon which this notice of investigation shall be served:

(a) The complainant is:
Realtek Semiconductor Corporation 2 Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan.

(b) The respondents are the following entities alleged to be in violation of section 337, and are the parties upon which the complaint is to be served:

LSI Corporation, 1621 Barber Lane, Milpitas, CA 95305.

Seagate Technology, 10200 S. DeAnza Boulevard, Cupertino, CA 95014.

(3) For the investigation so instituted, the Chief Administrative Law Judge, U.S. International Trade Commission, shall designate the presiding Administrative Law Judge.

The Office of Unfair Import Investigations will not participate as a party in this investigation.